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TITLE:  NI-860C3	DOCUMENT NO: 98ARH99040A	REV: J
	STANDARD: NON-JEDEC	
	SOT1856-1	18 MAR 2016



NOTES:

1. CONTROLLING DIMENSION: INCH
2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M-1994.
3. DIMENSION H IS MEASURED .030 (0.762) AWAY FROM PACKAGE BODY.
4. RECOMMENDED BOLT CENTER DIMENSION OF 1.140 (28.96) BASED 3M SCREW.

STYLE 1

- PIN 1: DRAIN
- PIN 2: DRAIN
- PIN 3: GATE
- PIN 4: GATE
- PIN 5: SOURCE

DIM	INCHES		MILLIMETERS		DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX		MIN	MAX	MIN	MAX
A	1.335	1.345	33.91	34.16	Q	.118	.138	3	3.30
B	.380	.390	9.65	9.91	R	.395	.405	10.03	10.29
C	.180	.224	4.57	5.69	S	.394	.406	10.01	10.31
D	.325	.335	8.26	8.51	bbb	.010		0.25	
E	.060	.070	1.52	1.78	ccc	.015		0.38	
F	.004	.006	0.10	0.15					
G	1.100 BSC		27.94 BSC						
H	.097	.107	2.46	2.72					
J	.2125 BSC		5.397 BSC						
K	.135	.165	3.43	4.19					
L	.425 BSC		10.8 BSC						
M	.852	.868	21.64	22.05					
N	.851	.869	21.62	22.07					

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